

# 1200V 30mohm Silicon Carbide Power MOSFET

## AKCK2M030WAM

### Features:

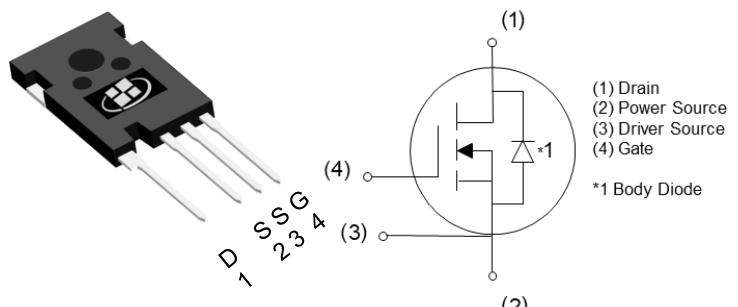
- Low on-resistance
- Fast switching speed with low capacitances
- Fast intrinsic diode with low reverse recovery ( $Q_{RR}$ )
- Halogen-free, RoHS compliant <sup>(Note 1)</sup>

### Applications:

- Motor drives
- DC/DC converters
- Switched mode power supplies
- Solar inverters

### Key Performance Parameters:

Parameter	Value	Unit
$V_{DS}$	1200	V
$R_{DS(ON)}$ , TYP @ $V_{GS} = 15$ V	30	mΩ
$R_{DS(ON)}$ , TYP @ $V_{GS} = 18$ V	25	mΩ
$I_D$	76	A
$P_D$	375	W



### Ordering Information:

Ordering Code	Package Type	Marking Code	Form	Packing
AKCK2M030WAM	TO-247-4L	CK2M030WAM	Tube	300 per box

### Notes:

1. Contact ALKAIDSEMI sales for detail information

## Maximum Ratings ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Units
$V_{DS}$	Drain-Source Voltage	1200	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ ) <sup>(Note 1)</sup>	76	A
	Drain Current - Continuous ( $T_C = 100^\circ\text{C}$ ) <sup>(Note 1)</sup>	54	A
$I_{DM}$	Drain Current - Pulsed <sup>(Note 2)</sup>	120	A
$V_{GS}$	Gate-Source Voltage (dynamic)	-8/+22	V
$V_{GS}$	Gate-Source Voltage (static)	-4/+18	V
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	375	W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +175	°C

## Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Steady-State	0.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Steady-State	40	°C/W

### Notes:

1. The max drain current limited by maximum junction temperature
2. Repetitive Rating: Pulse width limited by maximum junction temperature

**Electrical Characteristics** ( $T_J = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Static Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 100 \mu\text{A}$	1200			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 1200 \text{ V}, V_{\text{GS}} = 0 \text{ V}$		5	50	$\mu\text{A}$
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}} = 18 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			100	nA
		$V_{\text{GS}} = -4 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			100	nA
$V_{\text{GS(TH)}}$	Gate Threshold voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 11.5 \text{ mA}$	2	2.6	4	V
		$V_{\text{DS}} = V_{\text{GS}}, I_D = 11.5 \text{ mA}, T_J = 175^\circ\text{C}$		1.8		V
$R_{\text{DS(ON)}}$	Drain-Source on-state resistance	$V_{\text{GS}} = 15 \text{ V}, I_D = 40 \text{ A}$		30	40	$\text{m}\Omega$
		$V_{\text{GS}} = 15 \text{ V}, I_D = 40 \text{ A}, T_J = 175^\circ\text{C}$		48		$\text{m}\Omega$
		$V_{\text{GS}} = 18 \text{ V}, I_D = 40 \text{ A}$		25	34	$\text{m}\Omega$
		$V_{\text{GS}} = 18 \text{ V}, I_D = 40 \text{ A}, T_J = 175^\circ\text{C}$		45		$\text{m}\Omega$
$G_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = 20 \text{ V}, I_D = 40 \text{ A}$		27		S
		$V_{\text{DS}} = 20 \text{ V}, I_D = 40 \text{ A}, T_J = 175^\circ\text{C}$		28		S

**Dynamic Characteristics**

$C_{\text{ISS}}$	Input Capacitance	$V_{\text{DS}} = 800 \text{ V}, V_{\text{GS}} = 0 \text{ V}, F = 100 \text{ kHz}, V_{\text{AC}} = 25 \text{ mV}$		3545		pF
$C_{\text{OSS}}$	Output Capacitance			145		pF
$C_{\text{RSS}}$	Reverse Transfer Capacitance			13		pF
$E_{\text{OSS}}$	$C_{\text{OSS}}$ Stored Energy			58		$\mu\text{J}$
$R_G$	Gate Resistance	$F = 1 \text{ MHz}, V_{\text{AC}} = 25 \text{ mV}$		1		$\Omega$
$Q_{\text{GS}}$	Gate-Source Charge	$V_{\text{DS}} = 800 \text{ V}, I_D = 40 \text{ A}, V_{\text{GS}} = -4/+15 \text{ V}$		39		nC
$Q_{\text{GD}}$	Gate-Drain Charge			55		nC
$Q_G$	Total Gate Charge			155		nC

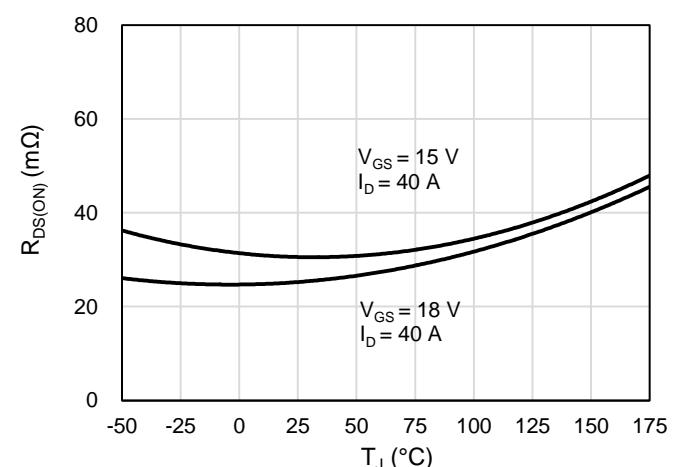
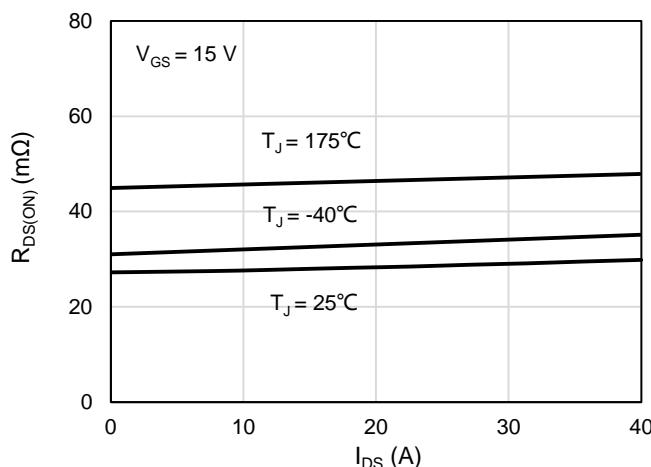
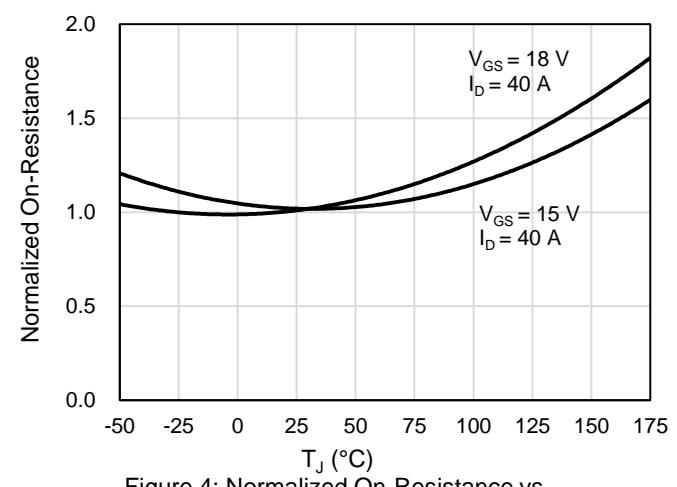
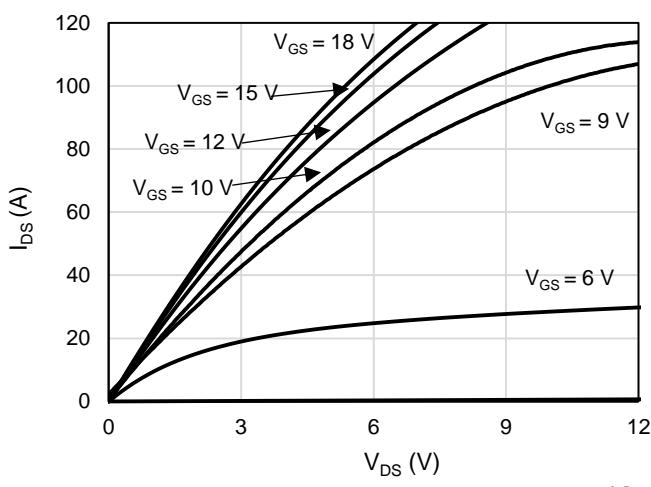
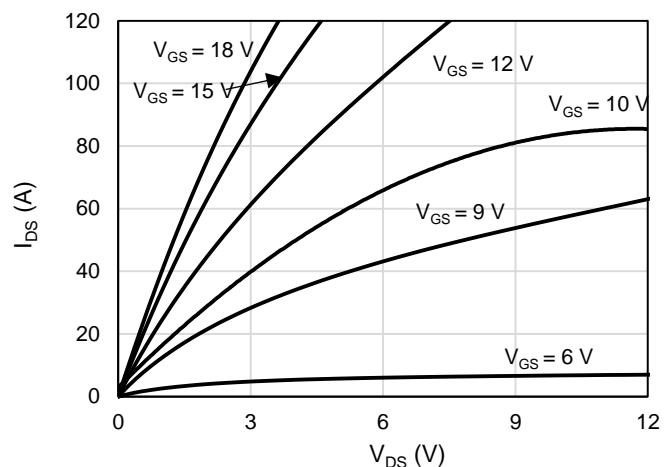
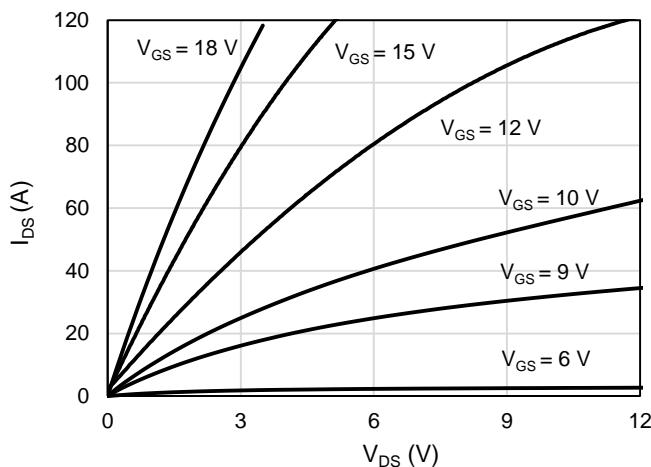
## Switching Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
$T_{D(ON)}$	Turn On Delay Time	$V_{DD} = 800 \text{ V}$ , $I_D = 40 \text{ A}$ , $V_{GS} = -4/+15 \text{ V}$ , $R_{G,EXT} = 2.5 \Omega$ $L = 40 \text{ nH}$  Diode: Body Diode at $V_{GS} = -4\text{V}$		14		ns
$T_R$	Rise Time			12		ns
$T_{D(OFF)}$	Turn Off Delay Time			45		ns
$T_F$	Fall Time			18		ns
$E_{ON}$	Turn On Energy			917		$\mu\text{J}$
$E_{OFF}$	Turn Off Energy			142		$\mu\text{J}$
$T_{D(ON)}$	Turn On Delay Time	$V_{DD} = 800 \text{ V}$ , $I_D = 40 \text{ A}$ , $V_{GS} = -4/+15 \text{ V}$ , $R_{G,EXT} = 2.5 \Omega$ $L = 40 \text{ nH}$  Diode: Body Diode at $V_{GS} = -4\text{V}$ $T_J = 175 \text{ }^\circ\text{C}$		10		ns
$T_R$	Rise Time			11		ns
$T_{D(OFF)}$	Turn Off Delay Time			52		ns
$T_F$	Fall Time			20		ns
$E_{ON}$	Turn On Energy			1066		$\mu\text{J}$
$E_{OFF}$	Turn Off Energy			178		$\mu\text{J}$

## Drain-Source Diode Characteristics ( $T_J = 25 \text{ }^\circ\text{C}$ unless otherwise noted)

$I_S$	Maximum Continuous Drain-Source Diode Forward Current			76	A
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current			120	A
$V_{SD}$	Diode Forward Voltage	$V_{GS} = -4 \text{ V}$ , $I_{SD} = 20 \text{ A}$		4	V
		$V_{GS} = -4 \text{ V}$ , $I_{SD} = 20 \text{ A}$ , $T_J = 175 \text{ }^\circ\text{C}$		3.5	V
$I_{RM}$	Peak Reverse Recovery Current	$V_{GS} = -4 \text{ V}$ , $I_{SD} = 40 \text{ A}$ , $V_R = 800 \text{ V}$ , $di/dt = 1150 \text{ A}/\mu\text{s}$		15	A
$T_{RR}$	Reverse Recovery Time			25	ns
$Q_{RR}$	Reverse Recovery Charge			172	nC
$I_{RM}$	Peak Reverse Recovery Current	$V_{GS} = -4 \text{ V}$ , $I_{SD} = 40 \text{ A}$ , $V_R = 800 \text{ V}$ , $di/dt = 1150 \text{ A}/\mu\text{s}$ $T_J = 175 \text{ }^\circ\text{C}$		21	A
$T_{RR}$	Reverse Recovery Time			41	ns
$Q_{RR}$	Reverse Recovery Charge			395	nC

## Electrical Characteristics Diagrams



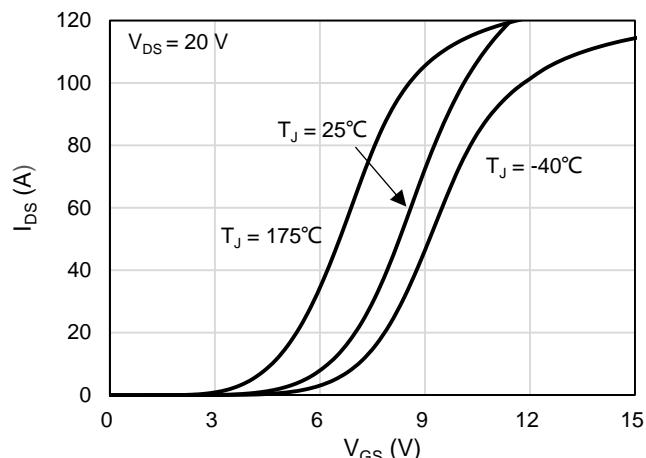


Figure 7: Transfer Characteristics For Various Junction Temperature

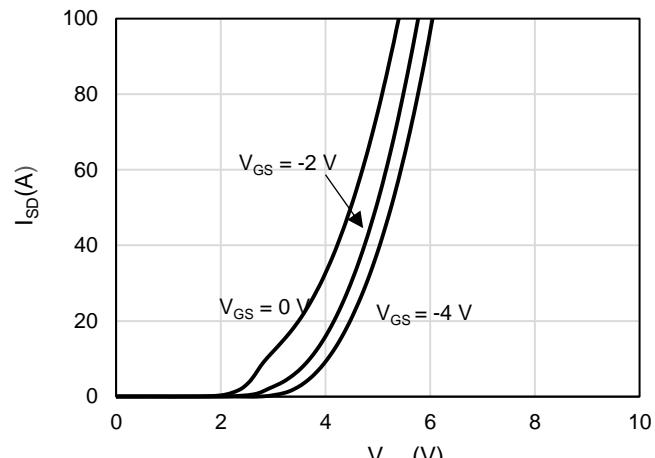
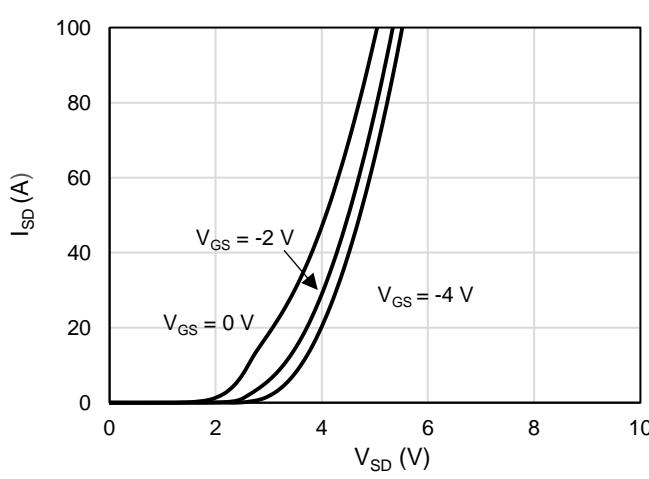
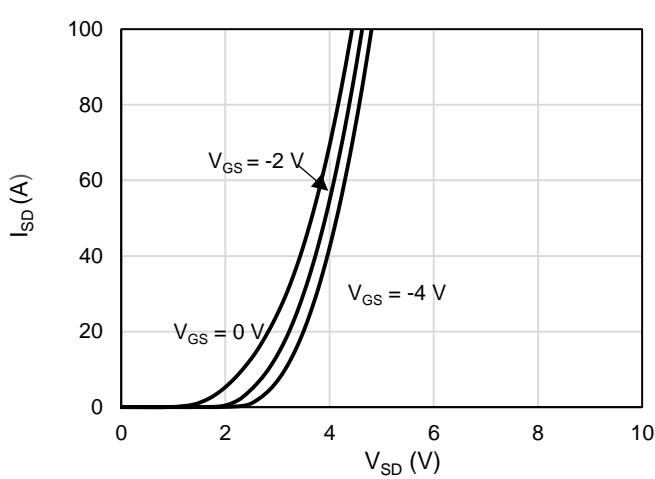
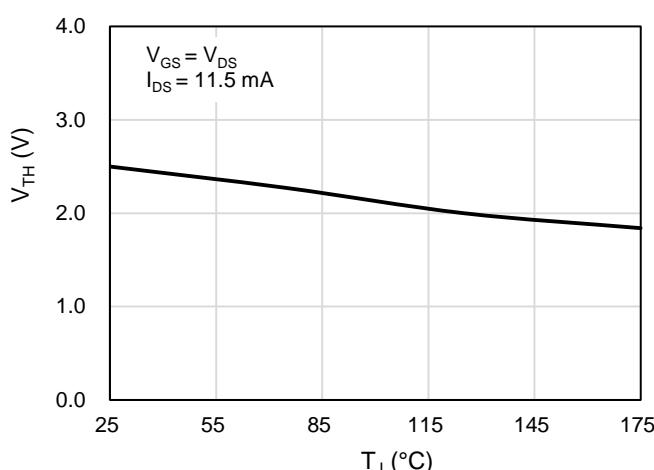
Figure 8: Body Diode Characteristics at  $-40^\circ\text{C}$ Figure 9: Body Diode Characteristics at  $25^\circ\text{C}$ Figure 10: Body Diode Characteristics at  $175^\circ\text{C}$ 

Figure 11: Threshold Voltage vs. Temperature

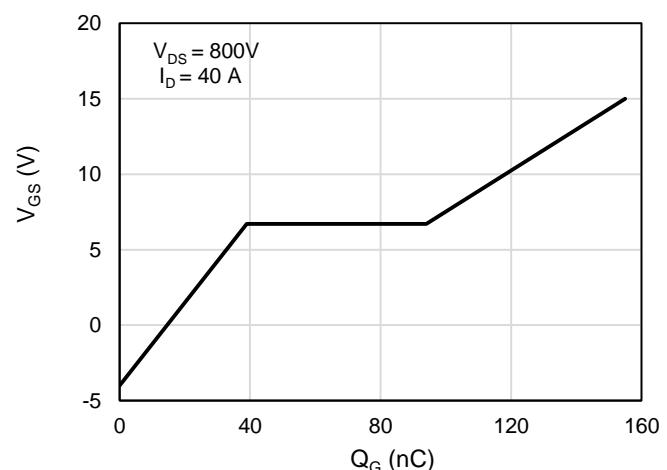
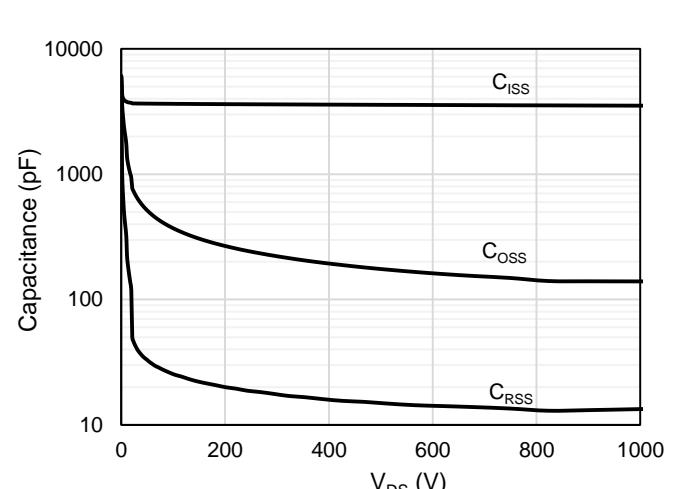
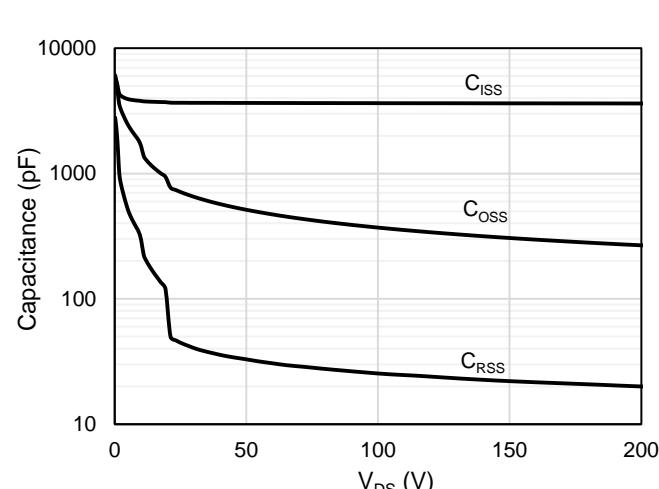
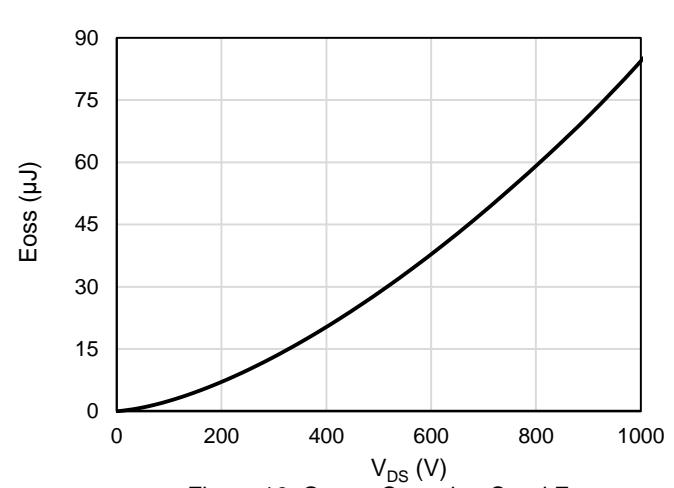
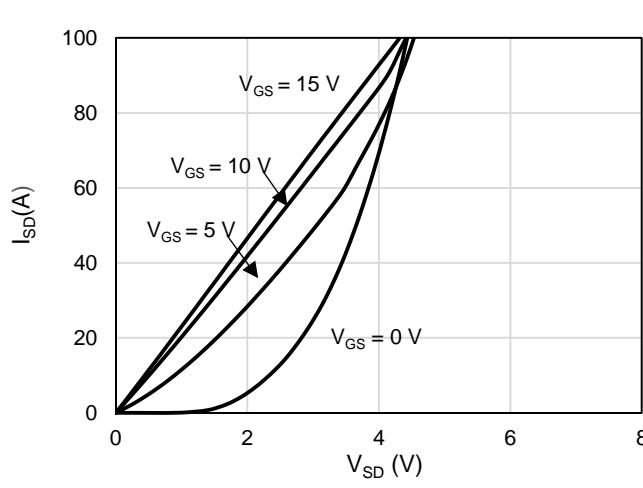
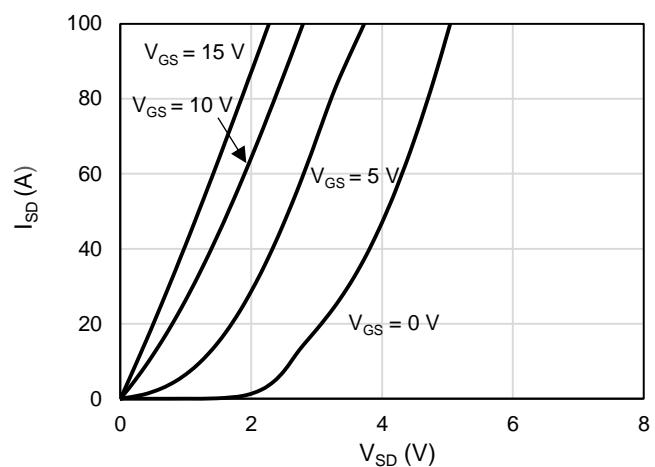
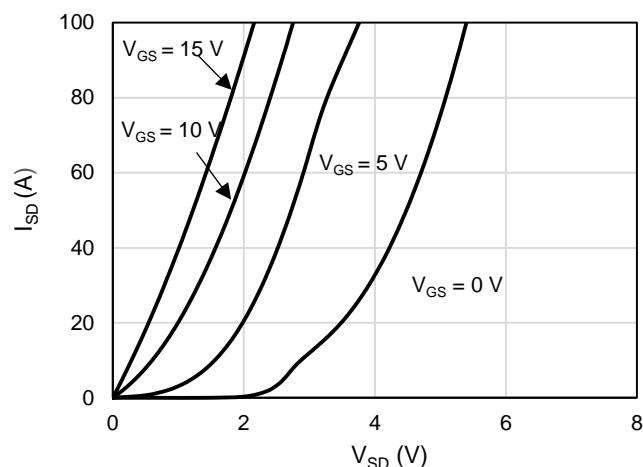
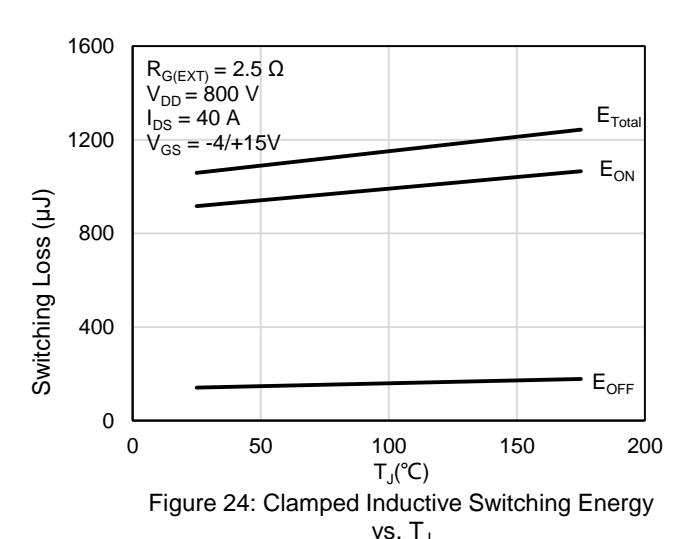
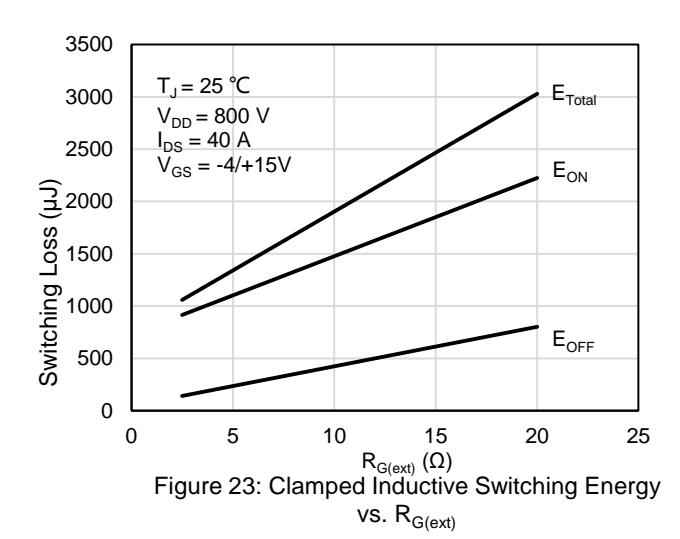
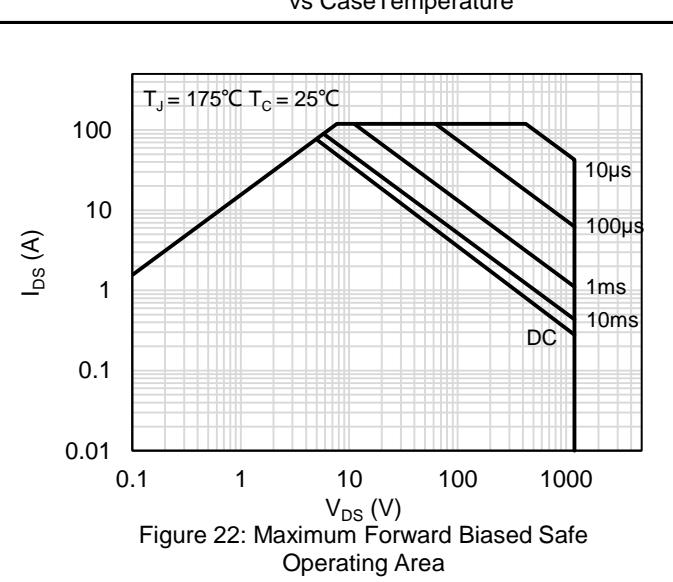
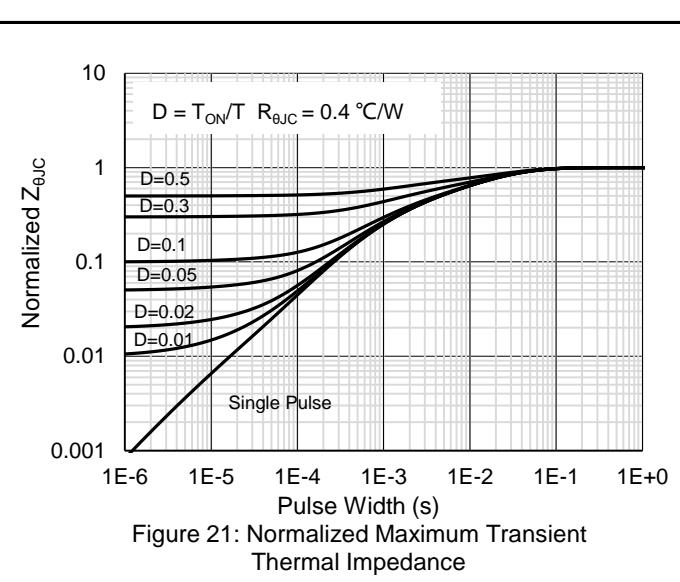
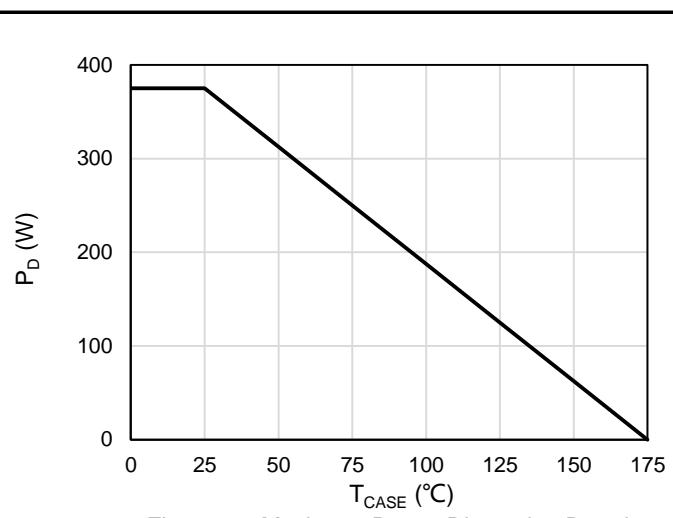
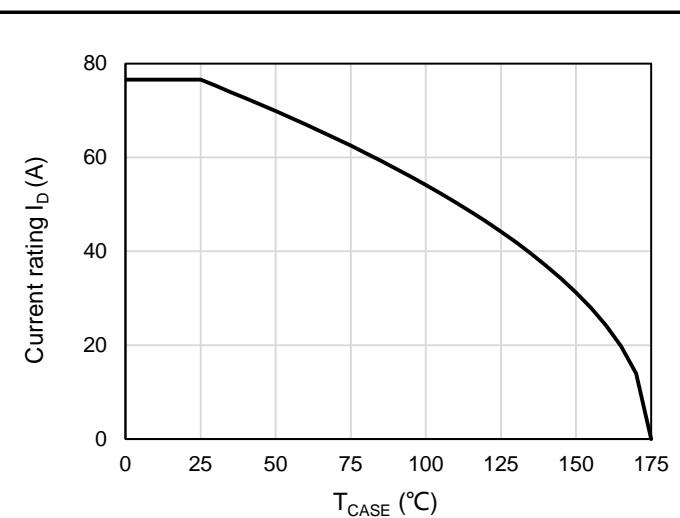
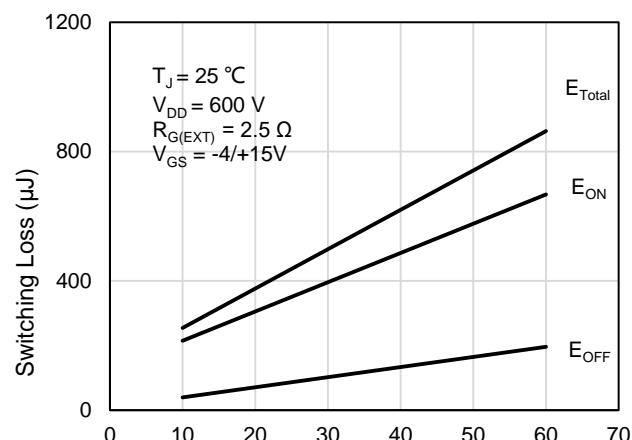
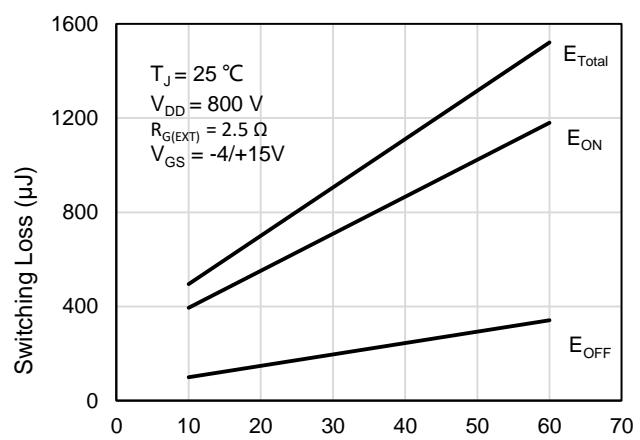
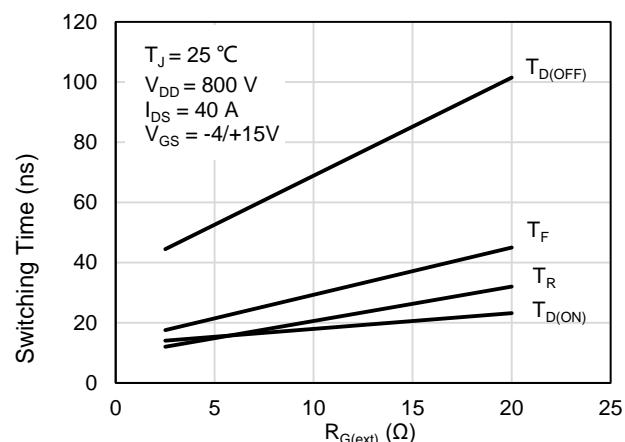


Figure 12: Gate-Charge Characteristics

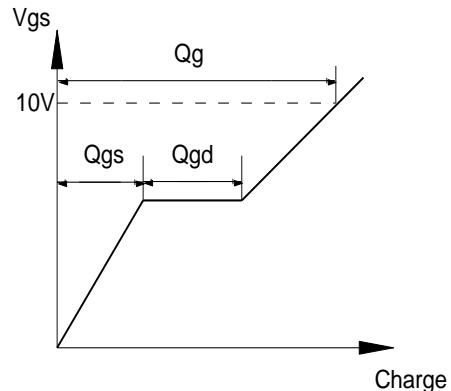
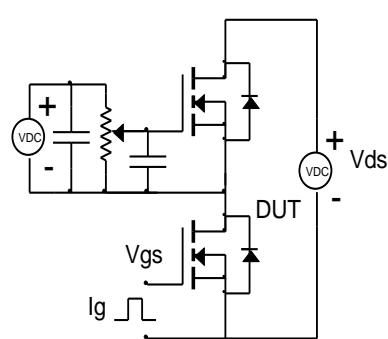




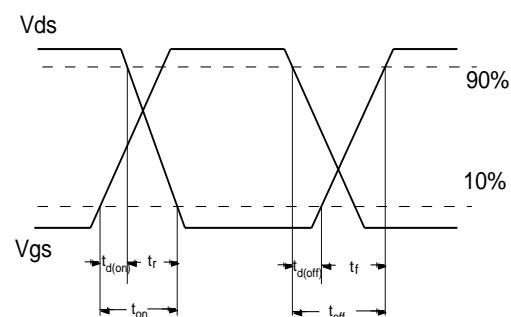
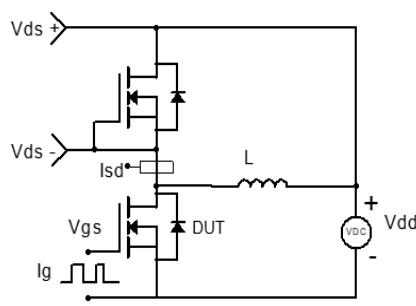
Figure 25: Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 600 \text{ V}$ )Figure 26: Clamped Inductive Switching Energy vs. Drain Current ( $V_{DD} = 800 \text{ V}$ )Figure 27: Clamped Inductive Switching Time vs.  $R_{G(ext)}$

## Test Circuit and Waveform

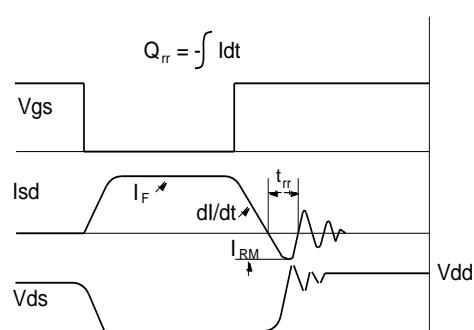
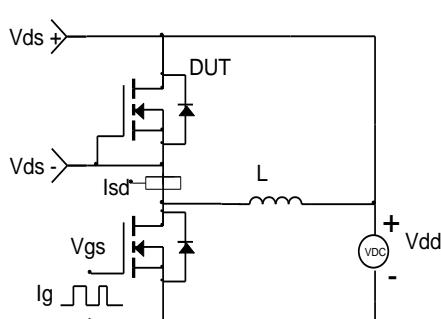
Gate Charge Test Circuit & Waveform



Clamped Inductive Switching Test Circuit & Waveforms

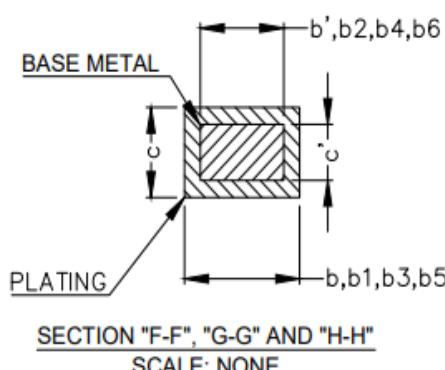
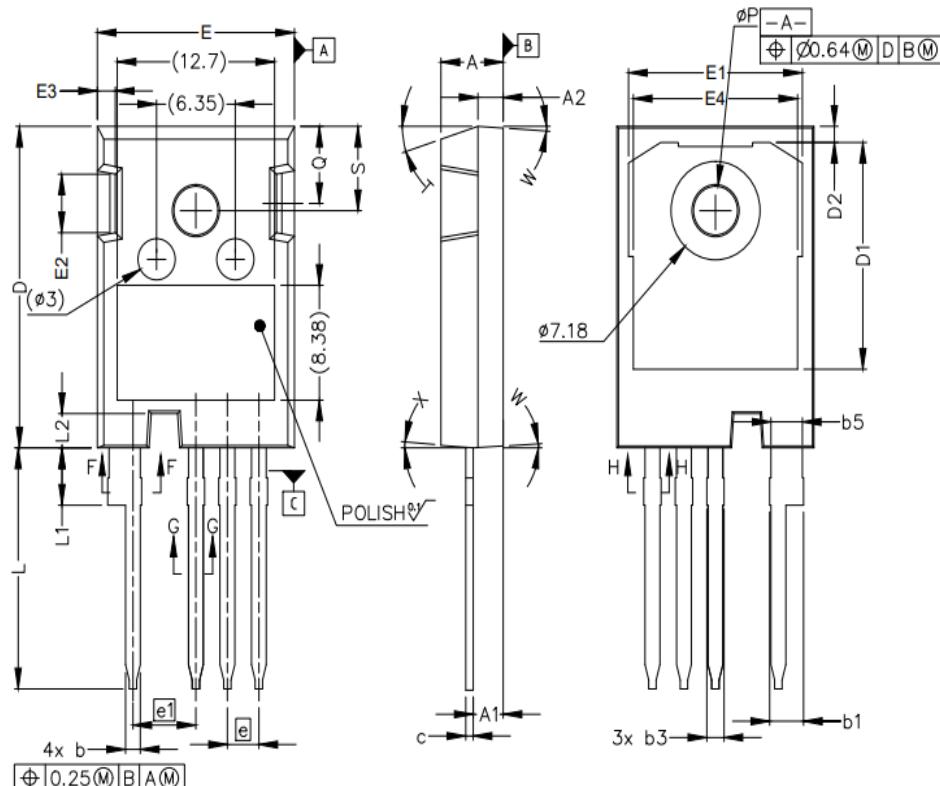


Diode Recovery Test Circuit & Waveforms



## Package Outlines

### TO-247-4L PKG Outlines



SYMBOL	MILLIMETERS	
	MIN	MAX
A	4.83	5.21
A1	2.29	2.54
A2	1.91	2.16
b'	1.07	1.28
b	1.07	1.33
b1	2.39	2.94
b2	2.39	2.84
b3	1.07	1.60
b4	1.07	1.50
b5	2.39	2.69
b6	2.39	2.64
c'	0.55	0.65
c	0.55	0.68
D	23.30	23.60
D1	16.25	17.65
D2	0.95	1.25
E	15.75	16.13
E1	13.10	14.15
E2	3.68	5.10
E3	1.00	1.90
E4	12.38	13.43
e	2.54 BSC	
e1	5.08 BSC	
N	4	
L	17.31	17.82
L1	3.97	4.37
L2	2.35	2.65
øP	3.51	3.65
Q	5.49	6.00
S	6.04	6.30
T	17.5° REF.	
W	3.5 ° REF.	
X	4° REF.	

## Marking Information



Note:

CK2M030WAM = Product Name Code

XXXXXXX = Date Code

Contact ALKAIDSEMI sales for detail information

## Revision History

Revision	Release Date	Remark
Rev.1.1	2023/6/12	

## Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Alkaidsemi assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

Due to product or technical improvements, the information described or contained herein may be changed without prior notice.